International

### REPETITIVE AVALANCHE AND dv/dt RATED HEXFET<sup>®</sup>TRANSISTORS THRU-HOLE (TO-205AF)

#### **Product Summary**

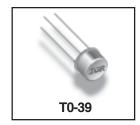
Part Number	BVDSS	RDS(on)	ld
IRFF220	200V	0.80Ω	3.5A

The HEXFET<sup>®</sup> technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of parelleling and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits. PD - 90427D

### IRFF220 JANTX2N6790 JANTXV2N6790 REF:MIL-PRF-19500/555 200V, N-CHANNEL



#### Features:

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Hermetically Sealed
- Simple Drive Requirements
- Ease of Paralleling

	Parameter		Units
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	3.5	
ID @ VGS = 10V, TC = 100°C	Continuous Drain Current	2.25	A
IDM	Pulsed Drain Current ①	14	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	20	W
	Linear Derating Factor	0.16	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	0.242	mJ
IAR	Avalanche Current ①	2.2	A
EAR	Repetitive Avalanche Energy ①	2.0	mJ
dv/dt	Peak Diode Recovery dv/dt 3	5.0	V/ns
TJ	Operating Junction	-55 to 150	
TSTG Storage Temperature Range			°C
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)	
	Weight	0.98(typical)	g

### **Absolute Maximum Ratings**

For footnotes refer to the last page

## International **tor** Rectifier

	Parameter	Min	Тур	Max	Units	<b>Test Conditions</b>
BVDSS	Drain-to-Source Breakdown Voltage	200	—	_	V	$V_{GS} = 0V, I_{D} = 1.0mA$
∆BV <sub>DSS</sub> /∆TJ	Temperature Coefficient of Breakdown Voltage	—	0.25	_	V/°C	Reference to 25°C, $I_D = 1.0$ mA
RDS(on)	Static Drain-to-Source On-State	_	—	0.80	0	VGS = 10V, ID = 2.25A ④
	Resistance	—	—	0.85	Ω	VGS =10V, ID =3.5A ④
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
9fs	Forward Transconductance	1.5	—	_	S	VDS > 15V, IDS = 2.25A ④
IDSS	Zero Gate Voltage Drain Current	_	—	25		V <sub>DS</sub> = 160V, V <sub>GS</sub> =0V
		_	—	250	μA	VDS = 160V
						$V_{GS} = 0V, T_{J} = 125^{\circ}C$
IGSS	Gate-to-Source Leakage Forward		—	100	nA	$V_{GS} = 20V$
IGSS	Gate-to-Source Leakage Reverse		—	-100		$V_{GS} = -20V$
Qg	Total Gate Charge	8.0	—	14.3		VGS =10V, ID =3.5A
Qgs	Gate-to-Source Charge	0.9	—	3.0	nC	V <sub>DS</sub> = 100V
Qgd	Gate-to-Drain ('Miller') Charge	2.3	—	9.0		
td(on)	Turn-On Delay Time	—	—	40		$V_{DD} = 74V, I_D = 3.5A,$
tr	Rise Time	—	—	50		$V_{GS} = 10V, R_{G} = 7.5\Omega$
<sup>t</sup> d(off)	Turn-Off Delay Time		—	50	ns	
tf	Fall Time	_	—	50		
L <sub>S +</sub> L <sub>D</sub>	Total Inductance		7.0		nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
Ciss	Input Capacitance	_	260			$V_{GS} = 0V, V_{DS} = 25V$
C <sub>OSS</sub>	Output Capacitance	_	100	_	pF	f = 1.0MHz
Crss	Reverse Transfer Capacitance	—	30	_		

### Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

### Source-Drain Diode Ratings and Characteristics

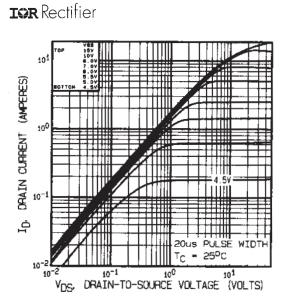
	Parameter		Min	Тур	Max	Units	Test Conditions
IS	Continuous Source Current	(Body Diode)	_	_	3.5	Α	
ISM	Pulse Source Current (Body	Diode) ①	—	—	14		
VSD	Diode Forward Voltage		—	_	1.5	V	Tj = 25°C, IS = 3.5A, VGS = 0V ④
t <sub>rr</sub>	Reverse Recovery Time		—	—	400	ns	Tj = 25°C, IF = 3.5A, di/dt $\leq$ 100A/ $\mu$ s
QRR	Reverse Recovery Charge		—	—	4.3	μC	$V_{DD} \le 50V $ (4)
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.					

### **Thermal Resistance**

	Parameter	Min	Тур	Мах	Units	Test Conditions
R <sub>thJC</sub>	Junction-to-Case	_	_	6.25	°C/W	
RthJA	Junction-to-Ambient	—	—	175	0/11	Typical socket mount.

Note: Corresponding Spice and Saber models are available on International Rectifier Website.

For footnotes refer to the last page



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Fig 1. Typical Output Characteristics

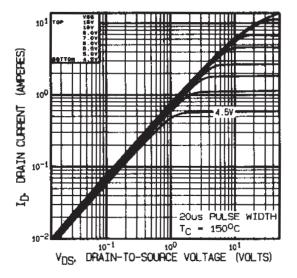
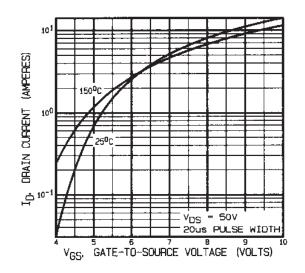
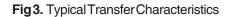
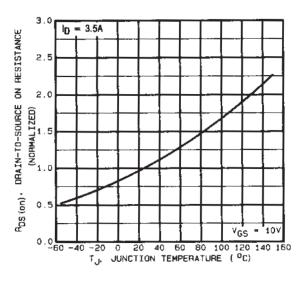
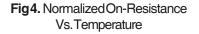


Fig 2. Typical Output Characteristics









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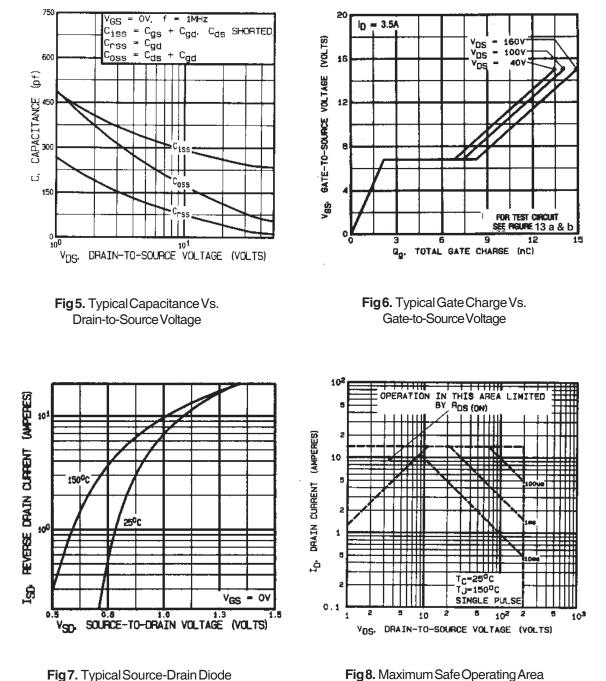
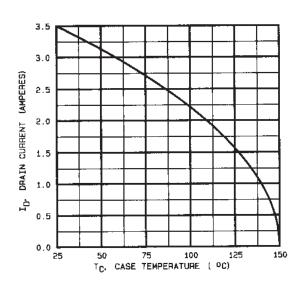
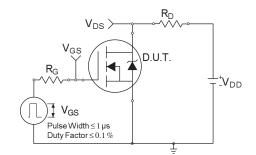


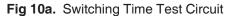
Fig7. Typical Source-Drain Diode Forward Voltage

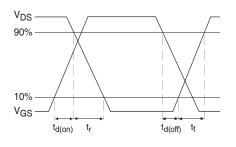
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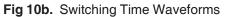












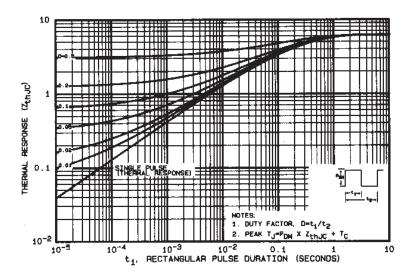


Fig11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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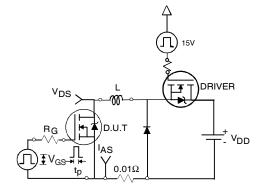
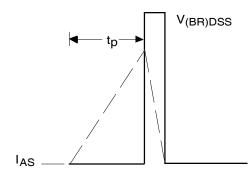
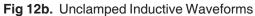
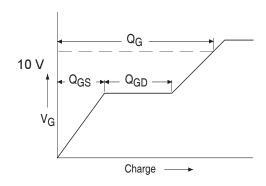


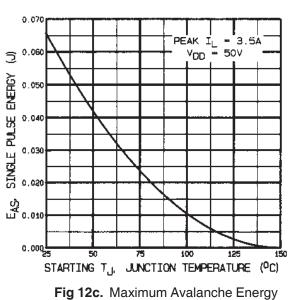
Fig 12a. Unclamped Inductive Test Circuit



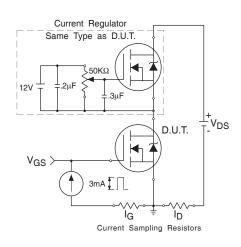








Vs. Drain Current

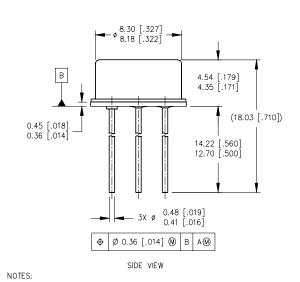




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### Foot Notes:

- ③ Repetitive Rating; Pulse width limited by maximum junction temperature.
  ③ V<sub>DD</sub> = 50V, starting T<sub>J</sub> = 25°C, Peak I<sub>L</sub> = 2.2A, L = 100μH
- \$\$ ISD ≤ 3.5A, di/dt ≤ 95A/μs, VDD≤ 200V, TJ ≤ 150°C Suggested RG =7.5 Ω
  \$\$ Pulse width ≤ 300 μs; Duty Cycle ≤ 2%



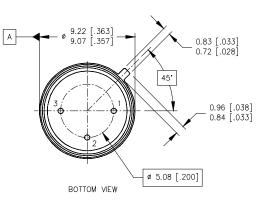
1. DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.

2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

4. CONFORMS TO JEDEC OUTLINE TO-205AF (TO-39).

3. CONTROLLING DIMENSION: INCH.

### Case Outline and Dimensions —TO-205AF



LEGEND 1- SOURCE 2- GATE 3- DRAIN

# International

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 IR LEOMINSTER : 205 Crawford St., Leominster, Massachusetts 01453, USA Tel: (978) 534-5776 TAC Fax: (310) 252-7903 Visit us at www.irf.com for sales contact information.

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